

IRF620NPBF-VB Datasheet N-Channel 200 V (D-S) MOSFET

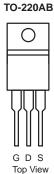
PRODUCT	PRODUCT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)		
200	0.270 at V _{GS} = 10 V	10		

FEATURES

- DT-Trench Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % Rg Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Primary Side Switch



G C S N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted) Symbol Limit Unit Parameter **Drain-Source Voltage** V_{DS} 200 V Gate-Source Voltage V_{GS} ± 20 T_C = 25 °C 10 Continuous Drain Current (T_J = 175 °C)^b I_{D} T_C = 125 °C 6 **Pulsed Drain Current** I_{DM} А 38 Continuous Source Current (Diode Conduction) I_{S} 12 Avalanche Current I_{AS} 10 Single Pulse Avalanche Energy L = 0.1 mH E_{AS} 18 mJ T_C = 25 °C 121^b Maximum Power Dissipation P_D W T_A = 25 °C 2^a Operating Junction and Storage Temperature Range °C T_J, T_{stg} - 55 to 175

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
hunding to Ambienta	t ≤ 10 s	P	15	18	
Junction-to-Ambient ^a	Steady State	R _{thJA}	40	50	°C/W
Junction-to-Case (Drain)		R _{thJC}	0.85	1.1	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. See SOA curve for voltage derating.

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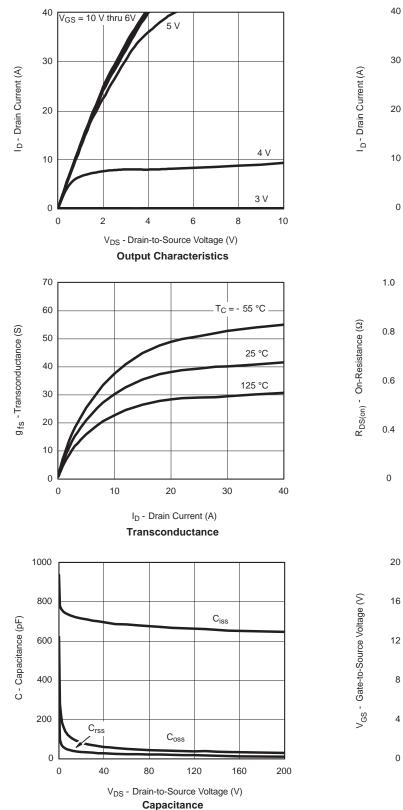
SPECIFICATIONS ($T_J = 25^{\circ}$			M	– 2	Ma	12.22	
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static				1 1	I		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	200			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
	I _{DSS}	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA	
Zero Gate Voltage Drain Current		V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 125 °C			50		
		$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			250		
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 V, V_{GS} = 10 V$	40			А	
		V _{GS} = 10 V, I _D = 5 A		0.270			
	R _{DS(on)}	V_{GS} = 10 V, I _D = 5 A, T _J = 125 °C		0.320			
Drain-Source On-State Resistance ^b		V _{GS} = 10 V, I _D = 5 A, T _J = 175 °C		0.410		Ω	
		V_{GS} = 4.5 V, I _D = 5 A		0.310			
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 19 A		35		S	
Dynamic ^a							
Input Capacitance	C _{iss}			800			
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, F = 1 MHz		110		pF	
Reverse Transfer Capacitance	C _{rss}			80			
Total Gate Charge ^c	Qg			30			
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 19 \text{ A}$		8		nC	
Gate-Drain Charge ^c	Q _{gd}			12			
Gate Resistance	Rg		0.5		2.9	Ω	
Turn-On Delay Time ^c	t _{d(on)}			15	25		
Rise Time ^c	t _r	V_{DD} = 100 V, R _L = 5.2 Ω		50	75		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ 19 A, V_{GEN} = 10 V, R_g = 2.5 Ω		30	45	ns	
Fall Time ^c	t _f			60	90		
Source-Drain Diode Ratings and Char	acteristics (1	Γ _C = 25 °C)					
Pulsed Current	I _{SM}				40	А	
Diode Forward Voltage ^b	V _{SD}	I _F = 19 A, V _{GS} = 0 V		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 19 A, dl/dt = 100 A/μs		180	250	ns	

Notes:

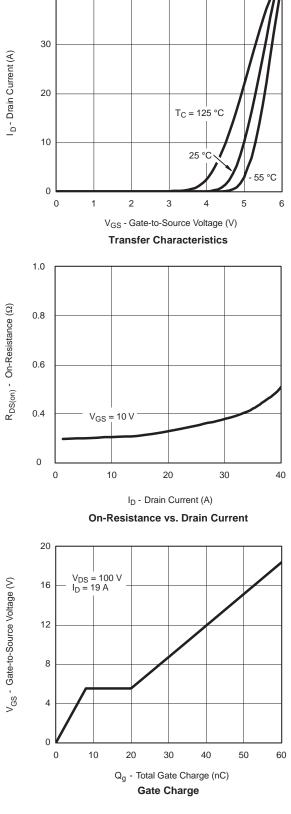
a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

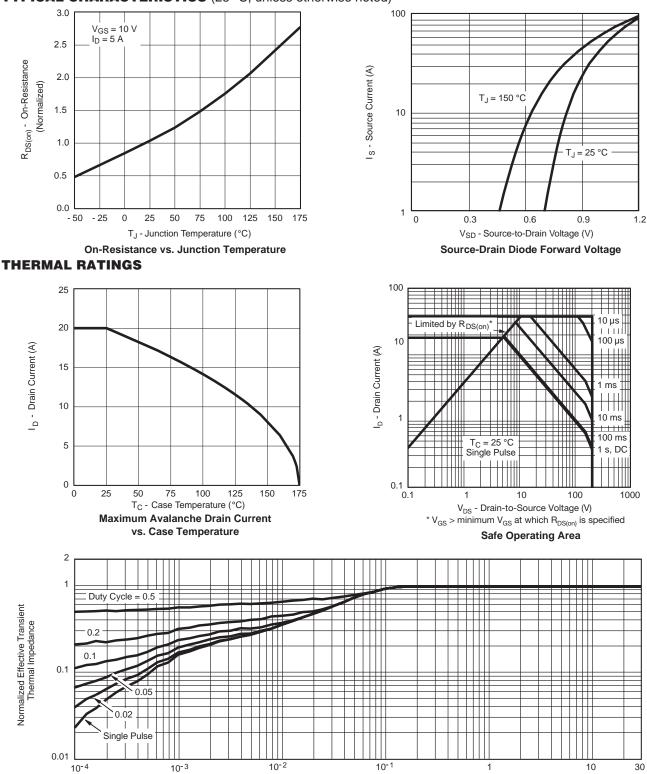




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





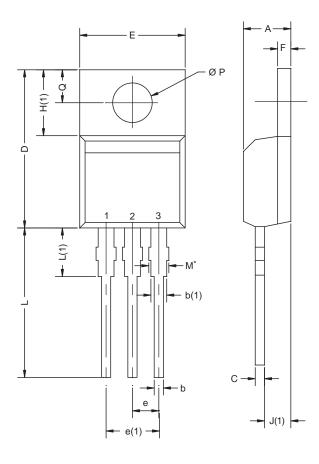


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Case



TO-220AB



MIN. 4.25 0.69 1.20 0.36 14.85 10.04 2.41	MAX. 4.65 1.01 1.73 0.61 15.49 10.51	MIN. 0.167 0.027 0.047 0.014 0.585 0.395	MAX. 0.183 0.040 0.068 0.024 0.610 0.414
0.69 1.20 0.36 14.85 10.04	1.01 1.73 0.61 15.49 10.51	0.027 0.047 0.014 0.585	0.040 0.068 0.024 0.610
1.20 0.36 14.85 10.04	1.73 0.61 15.49 10.51	0.047 0.014 0.585	0.068 0.024 0.610
0.36 14.85 10.04	0.61 15.49 10.51	0.014 0.585	0.024 0.610
14.85 10.04	15.49 10.51	0.585	0.610
10.04	10.51		
		0.395	0.414
2.41			0.414
	2.67	0.095	0.105
4.88	5.28	0.192	0.208
1.14	1.40	0.045	0.055
6.09	6.48	0.240	0.255
2.41	2.92	0.095	0.115
13.35	14.02	0.526	0.552
3.32	3.82	0.131	0.150
3.54	3.94	0.139	0.155
2.60	3.00	0.102	0.118
	1.14 6.09 2.41 13.35 3.32 3.54 2.60	1.14 1.40 6.09 6.48 2.41 2.92 13.35 14.02 3.32 3.82 3.54 3.94	1.141.400.0456.096.480.2402.412.920.09513.3514.020.5263.323.820.1313.543.940.1392.603.000.102

Notes

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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